

# **Application Data Sheet**

## **Application Information**

Application Type::	Regular
Subject Matter::	Utility
Title::	HIGH EFFICIENCY MICROLENS ARRAY
Attorney Docket Number::	24061.180 (TSMC2003-1127)
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	1
Total Drawing Sheets::	1
Small Entity::	No
Petition Included?::	No
Secrecy Order in Parent App.?::	No

## **Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Taiwan, R.O.C.
Given Name::	Dun-Nian
Family Name::	Yaung
City of Residence::	Taipei City
Country of Residence::	Taiwan
Street of Mailing Address::	4F, No. 15, Lane 130, Wansheng St. Wunshan District
City of Mailing Address::	Taipei City
Country of Mailing Address::	Taiwan, R.O.C.
Postal or Zip Code of Mailing Address::	116

## Correspondence Information

Correspondence Customer Number:: 27683  
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## Representative Information

Representative Customer Number::	27683
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## Assignee Information

Assignee Name:: Taiwan Semiconductor Manufacturing Co. Ltd.  
Street of Mailing Address:: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park  
City of Mailing Address:: Hsin-Chu  
Country of Mailing Address:: Taiwan, R.O.C.  
Postal or Zip Code of Mailing Address:: 300-77

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